

| VDS   | RDS(on) | ID@25℃ |  |  |
|-------|---------|--------|--|--|
| 1200V | 75mΩ    | 33A    |  |  |

## **Applications:**

- Solar Inverters
- Switch Mode Power Supplies
- High Voltage DC/DC Converters
- EV Charging
- Motor Drives

#### **Features:**

- High Blocking Voltage with Low On-Resistance
- High Speed Switching with Low Capacitances
- Easy to Parallel and Simple to Drive
- Avalanche Ruggedness

### **Benefits:**

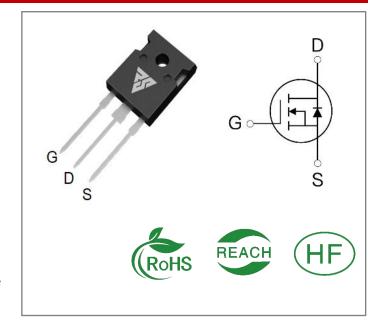
- Higher System Efficiency
- Reduced Cooling Requirements
- Increased Power Density
- Increased System Switching Frequency

### **Ordering Information**

| Part Number | Package  | Marking    | Packing | Qty.   |
|-------------|----------|------------|---------|--------|
| RSM120075W  | TO-247-3 | RSM120075W | Tube    | 30 PCS |

# Maximum Ratings (TJ= 25°C unless otherwise specified)

| Symbol    | Parameter                                 | Value           | Unit         | Test Conditions                         | Note |
|-----------|---|-----------------|--------------|---|------|
| VDSmax    | Drain - Source Voltage                    | 1200            | V            | VGS=0V,ID =100μA                        |      |
| VGSmax    | Gate - Source Voltage                     | -8/+22          | V            | Absolute maximum values                 |      |
| VGSop     | Gate - Source Voltage                     | -4/+18          | V            | Recommended operational values          |      |
| ID        | Continuous Drain<br>Current               | 33<br>23.8      | А            | VGS=18V, TC =25°C<br>VGS=18V, TC =100°C |      |
| ID(pulse) | Pulsed Drain Current                      | 80              | Α            | Pulse width tp limited by TJmax         |      |
| PD        | Power Dissipation                         | 136             | W            | TC =25℃, TJ =175℃                       |      |
| TL        | Solder Temperature                        | 260             | $^{\circ}$ C |   |      |
| TJ, Tstg  | Operating Junction and StorageTemperature | -55 to<br>+ 175 | $^{\circ}$ C |   |      |





# **Electrical Characteristics** (TJ= 25 °C unless otherwise specified)

| Symbol       | Parameter                          | Min.     | Тур.     | Max. | Unit         | Test Conditions                                       | Note |
|--------------|------------------------------------|----------|----------|------|--------------|---|------|
| V(BR)D<br>SS | Drain-Source<br>Breakdown Voltage  | 120<br>0 |          |      | ٧            | VGS=0V,ID =100μA                                      |      |
| \/C\$(+b)    | Gate Threshold                     | 1.9      | 2.6      | 4.0  | V            | VGS= VDS, IDS=5mA,<br>TC =25°C                        |      |
| VGS(th)      | Voltage                            |          | 1.8      |      | V            | VGS= VDS, IDS=5mA,<br>TC =175°C                       |      |
| IDSS         | Zero Gate Voltage<br>Drain Current |          | 1        | 100  | μΑ           | VDS= 1200V, VGS=0V                                    |      |
| IGSS+        | Gate-Source Leakage<br>Current     |          | 10       | 250  | nA           | VGS=22V, VDS= 0V                                      |      |
| IGSS-        | Gate-Source Leakage<br>Current     |          | 10       | 250  | nA           | VGS=-8V, VDS= 0V                                      |      |
| DDC()        | Drain-Source on-state              |          | 75       | 95   | mΩ           | VGS=18V, ID =20A,<br>TC =25℃                          |      |
| RDS(on)      | Resistance                         |          | 120      |      |              | VGS=18V, ID =20A,<br>TC =175℃                         |      |
| Ciss         | Input Capacitance                  |          | 120<br>0 |      |              | VGS=0V,<br>VDS=1000 V,                                |      |
| Coss         | Output Capacitance                 |          | 63       |      | pF           | f=1MHz,   |      |
| Crss         | Reverse Transfer Capacitance       |          | 9.8      |      |              | VAC=25 mV   |      |
| EON          | Turn-On Switching<br>Energy        |          | 586      |      | μЈ           | VDS =800V, VGS =-4/18V,<br>ID = 20A,                  |      |
| EOFF         | Turn-Off Energy                    |          | 273      |      |              | RG(ext) = $2.5\Omega$ , L= $100\mu$ H                 |      |
| td(on)       | Turn-On Delay Time                 |          | 13       |      |              |   |      |
| tr           | Rise Time                          |          | 12       |      |              | VDS =800V, VGS =-4/18 V                               |      |
| td(off)      | Turn-Off Delay Time                |          | 16       |      | ns           | ID = 20A, RG(ext) =2. 5 $\Omega$ ,<br>RL =20 $\Omega$ |      |
| tf           | Fall Time                          |          | 10       |      |              | 2032  |      |
| RG(int)      | Internal Gate<br>Resistance        |          | 5.5      |      | Ω            | f=1 MHz, VAC=25mV                                     |      |
| Qgs          | Gate to Source Charge              |          | 21.5     |      | nC VDS=800V, |   |      |
| Qgd          | Gate to Drain Charge               |          | 14.6     |      | nC           | VGS=-4/18V  |      |
| Qg           | Total Gate Charge                  |          | 68.1     |      |              | ID =20A   |      |



# Reverse Diode Characteristics (TJ= 25°C unless otherwise specified)

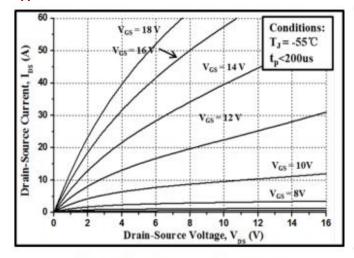
| Symbol | Parameter                           | Тур. | Max | Unit | Test Conditions                | Note |
|--------|-------------------------------------|------|-----|------|--------------------------------|------|
| VCD    | Diada Famusud Valtaga               | 4.2  |     | ٧    | VGS=-4V, ISD =10 A, TJ = 25℃   |      |
| VSD    | Diode Forward Voltage               | 3.8  |     | ٧    | VGS=-4V, ISD=10 A,<br>TJ= 175℃ |      |
| IS     | Continuous Diode Forward<br>Current |      | 33  | А    | VGS=-4V,TC= 25°C               |      |
| trr    | Reverse Recovery time               | 28   |     | ns   |                                |      |
| Qrr    | Reverse Recovery Charge             | 62   |     | nC   | ISD= 20A,<br>VR = 800V         |      |
| Irrm   | Peak Reverse Recovery Current       | 3.7  |     | А    | VIX 500V                       |      |

# Thermal Characteristics (TJ= 25℃ unless otherwise specified)

| Symbol | Parameter                                   |      | Unit    | Test<br>Conditions | Note |
|--------|---|------|---------|--------------------|------|
| RθJC   | Thermal Resistance from Junction to Case    | 0.84 | °C /\A/ |                    |      |
| RθJA   | Thermal Resistance From Junction to Ambient | 40   | °C/W    |                    |      |



### **Typical Feature Curve**



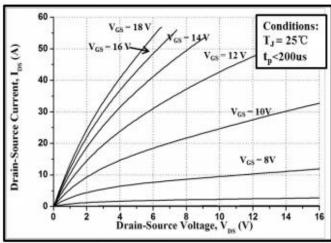
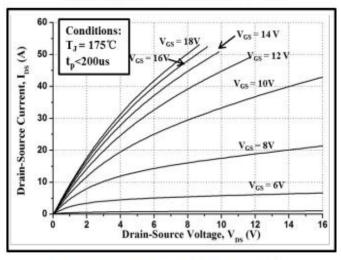


Figure 1. Output Characteristics T₁ = -55 ℃





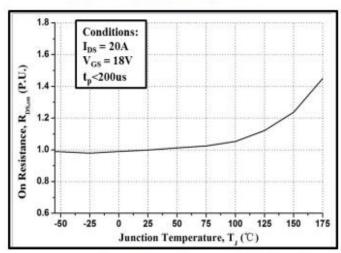
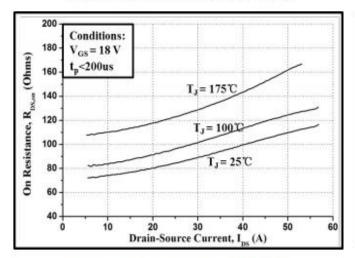


Figure 3. Output Characteristics T₁ = 175℃

Figure 4. Normalized On-Resistance vs. Temperature



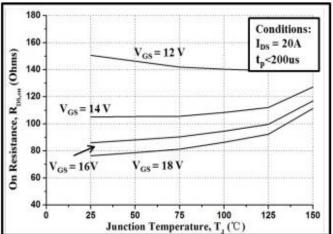


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

Figure 6. On-Resistance vs. Temperature For Various Gate Voltage



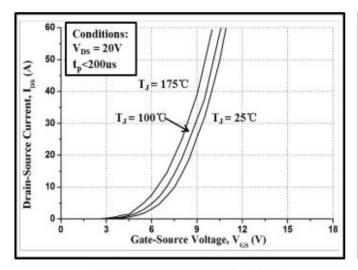


Figure 7. Transfer Characteristic for Various Junction Temperatures

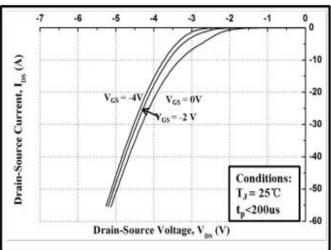


Figure 8. Body Diode Characteristic at 25°C

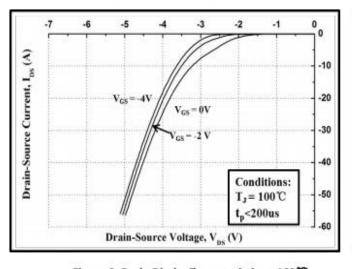


Figure 9. Body Diode Characteristic at 100 ℃

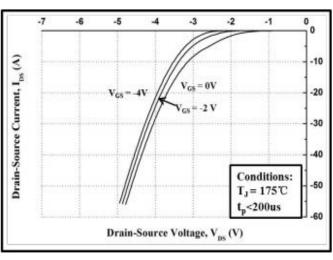


Figure 10. Body Diode Characteristic at 175°C

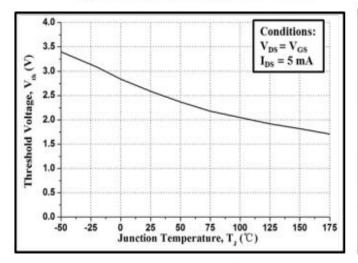


Figure 11. Threshold Voltage vs. Temperature

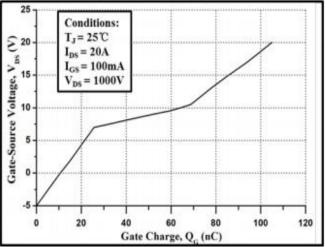


Figure 12. Gate Charge Characteristics



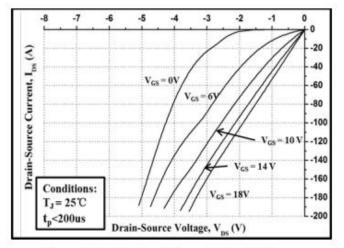


Figure 13. 3rd Quadrant Characteristic at 25°C

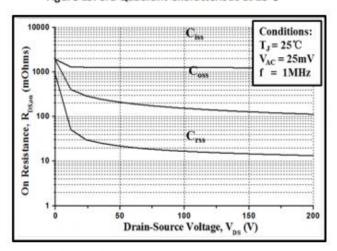


Figure 15. Capacitances vs. Drain-Source Voltage (0 - 200V)

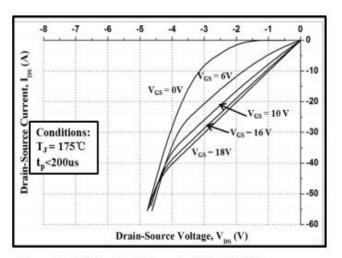


Figure 14. 3rd Quadrant Characteristic at 175°C

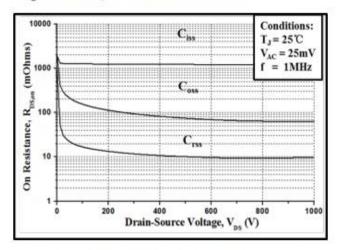
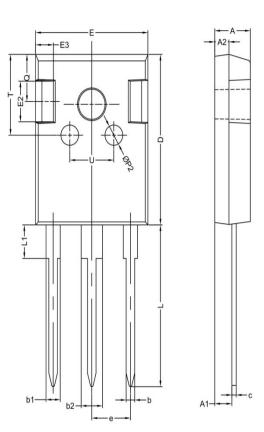
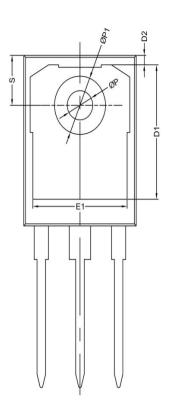


Figure 16. Capacitances vs. Drain-Source Voltage (0 - 1000V)



# Package outline drawing(TO-247-3 Unit: mm)





| WA EL |       | 机械尺寸/mr | n     |  |  |
|-------|-------|---------|-------|--|--|
| 符号    | 最小值   | 典型值     | 最大值   |  |  |
| Α     | 4.80  | 5.00    | 5.20  |  |  |
| A1    | 2.21  | 2.41    | 2.61  |  |  |
| A2    | 1.90  | 2.00    | 2.10  |  |  |
| b     | 1.10  | 1.20    | 1.35  |  |  |
| b1    |       | 2.00    |       |  |  |
| b2    |       | 3.00    |       |  |  |
| С     | 0.55  | 0.60    | 0.75  |  |  |
| D     | 20.80 | 21.00   | 21.20 |  |  |
| D1    |       | 16.55   |       |  |  |
| D2    |       | 1.20    |       |  |  |
| E     | 15.60 | 15.80   | 16.0  |  |  |
| E1    |       | 13.30   |       |  |  |
| E2    |       | 5.00    |       |  |  |
| E3    |       | 2.50    |       |  |  |
| е     |       | 5.44    |       |  |  |
| L     | 19.42 | 19.92   | 20.42 |  |  |
| L1    |       | 4.13    |       |  |  |
| Р     | 3.50  | 3.60    | 3.70  |  |  |
| P1    | -     | -       | 7.40  |  |  |
| P2    |       | 2.50    |       |  |  |
| Q     |       | 5.80    |       |  |  |
| S     | 6.05  | 6.15    | 6.25  |  |  |
| Т     |       | 10.00   |       |  |  |
| U     |       | 6.20    |       |  |  |





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